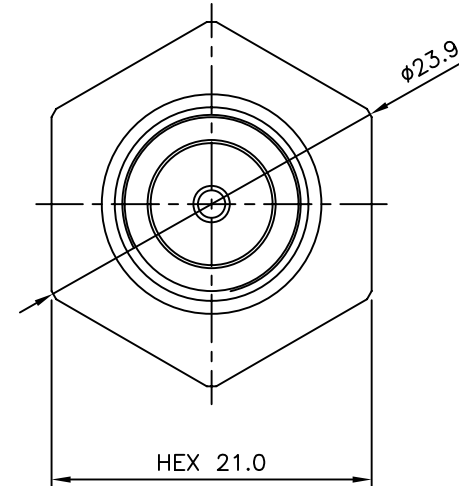
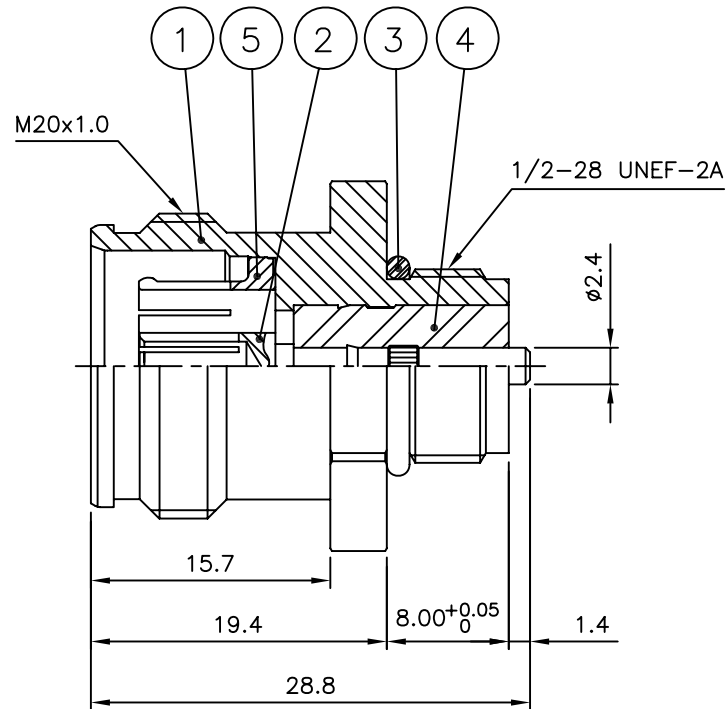
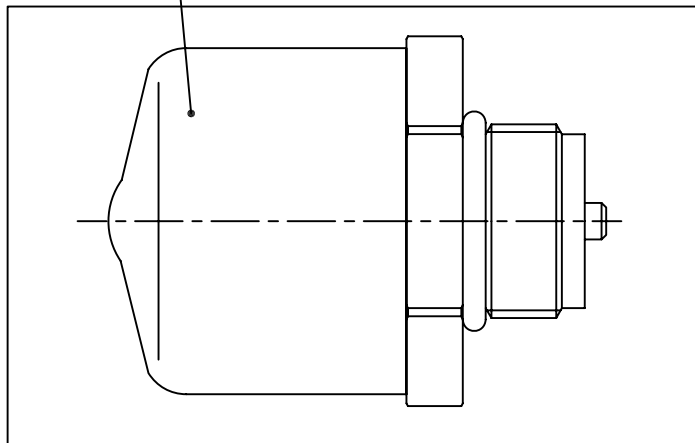


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2016. 05. 25.
1	Jack 텐션 조정 및 PIN 커팅 (4->6) 수정	I.C.KIM		2016. 08. 11.
2	[설번처리No.201704-0011] JACK 표준화 적용 CODE로 변경	I.C.KIM		2017. 04. 27.
3	[설번처리No.201705-0007] 고객 요청에 의한 END CAP 추가	S.Y.EUN	I.C.KIM	2017. 05. 29.



필텍

6 * 포장시 END CAP 적용 할 것.



3	6	END CAP	1	PVC	RED	DGK00224-N/3
2	5	JACK	1	MBsBD C3604BD-F	Silver Plate (3μm)	DJA00228-5/6 DJA00228-5/5
	4	INSULATOR	1	TEFLON		DIN02769-N/1
	3	GASKET	1	SILICONE RUB		DGK00121-N/1
1	2	CONTACT	1	BeCu C17300	Silver Plate (5μm)	DCT03695-5/3 DCT03695-5/1
	1	BODY	1	MBsBD C3604BD-F	SUCO Plate (3μm)	DBD04165-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 05. 29.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE 4.3-10 DIN50 SOLDER END JB (F/F)
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	2/1	A4 DWG NO. CN03601-7/3 REVISION 3 SHEET 1 of 1
		UNIT	mm	